

UP SuperServer SYS-110P-WTR

1U WIO with 10 hot-swap 6 SAS/SATA + 4 NVMe/SAS/SATA bays and 3 PCIe 4.0 x16 slots



More details here

Key Applications

Virtualization, Cloud Computing, Enterprise Server, Data Center Optimized, Database Processing and Storage,

Key Features

- Single Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable processors. Up to 270W TDP.;
- 8 DIMMs; Supports 3DS DDR4-3200: RDIMM/LRDIMM/Intel® Intel® DCPMM;
- 2 PCIe 4.0 x16 (FHFL) slots, 1 PCIe 4.0 x16 (LP) slot;
- Intel® Ethernet Controller X550 2x 10GbE RJ45;
- 10x hot-swap 2.5" SATA3 drive bays with 4 hybrid NVMe/SATA drive bays, SAS3 with additional SAS controller card; Onboard 1x NVMe/SATA M.2.;
- Redundant Platinum 750W Power Supply;



Form Factor	1U Rackmount Enclosure: 437 x 43 x 597mm (17.2" x 1.7" x 23.5") Package: 609.6 x 203.2 x 812.8mm (24" x 8" x 32")
Processor	Single Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable processors Up to 40C/80T; Up to 60MB Cache
GPU	Max GPU Count: Up to 1 single-width GPU(s) Supported GPU: NVIDIA PCIe: T400, T1000, A2 CPU-GPU Interconnect: PCIe 4.0 x16 CPU-to-GPU Interconnect
System Memory	Slot Count: 8 DIMM slots Max Memory (1DPC): Up to 2TB 3200MT/s ECC DDR4 RDIMM/LRDIMM Supports Intel® Optane™ persistent memory 200 series
Drive Bays Configuration	Default: Total 10 bay(s) <ul style="list-style-type: none"> • 6 front hot-swap 2.5" SAS*/SATA drive bay(s) • 4 front hot-swap 2.5" PCIe 4.0 NVMe*/SAS*/SATA drive bay(s) (*NVMe/SAS support may require additional storage controller and/or cables, please see the optional parts list for details) M.2: 1 M.2 PCIe 3.0 x4 NVMe/SATA slot(s) (M-key 2280/22110)
Expansion Slots	Default <ul style="list-style-type: none"> • 2 PCIe 4.0 x16 FHFL slot(s) • 1 PCIe 4.0 x16 LP slot(s)
On-Board Devices	SATA: SATA (6Gbps) ; RAID 0/1/5/10 support NVMe: NVMe; RAID 0/1/5/10 support(Intel® VROC RAID key required) Chipset: Intel® C621A Network Connectivity: 2 RJ45 10GbE with Intel® X550
Input / Output	LAN: 2 RJ45 10 GbE LAN port(s) 1 RJ45 1 GbE Dedicated IPMI LAN port(s) (IPMI shared on LAN port 1) USB: 2 USB 2.0 port(s) (header) 2 USB 3.2 Gen1 Type-A port(s) (rear) 2 USB 2.0 Type-A port(s) (rear) 2 USB 3.2 Gen1 Type-A port(s) (front) 1 USB 3.2 Gen1 Type-A port(s) Video: 1 VGA 2 port(s) Serial: 1 COM port(s) (Rear) 1 COM port(s) (Header) DOM: 2 SuperDOM (Disk on Module) port(s) with built-in power TPM: 1 TPM header

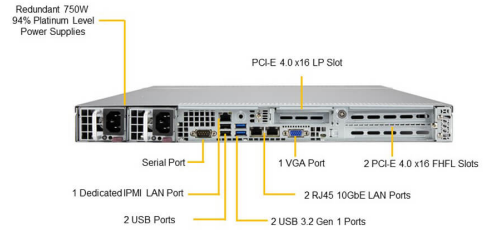
(Front View – System)



Drive Bay	Description
1 - 2	10x 2.5" Hot-swap SAS/SATA3 Drive Bays
3 - 4	4x Hot-swap NVMe Hybrid SAS/SATA3 Drive Bays(Optional)

*SAS/NVMe support requires additional parts in optional parts list
 ** NVMe tray are optional

(Rear View – System)



System Cooling	Fans: 5 counter-rotation PWM 40x40x56mm Fan(s) 1 AOC cooling Fan(s) (optional)
Power Supply	2x 750W Redundant (1 + 1) Platinum Level (94%) power supplies
System BIOS	BIOS Type: AMI 32MB SPI Flash EEPROM
Management	SuperCloud Composer; Supermicro Server Manager (SSM); Supermicro Update Manager (SUM); Supermicro SuperDoctor® 5 (SD5); Super Diagnostics Offline (SDO); Supermicro Thin-Agent Service (TAS); SuperServer Automation Assistant (SAA) New!
PC Health Monitoring	CPU: Monitors for CPU Cores, Chipset Voltages, Memory 7+1 Phase-switching voltage regulator FAN: Fans with tachometer monitoring Status monitor for speed control Pulse Width Modulated (PWM) fan connectors Temperature: Monitoring for CPU and chassis environment Thermal Control for fan connectors
Dimensions and Weight	Weight: Gross Weight: 38 lbs (17.24 kg) Net Weight: 25 lbs (11.34 kg) Available Color: Black
Operating Environment	Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F) Non-operating Temperature: -40°C to 70°C (-40°F to 158°F) Operating Relative Humidity: 8% to 90% (non-condensing) Non-operating Relative Humidity: 5% to 95% (non-condensing)
Motherboard	Super X12SPW-TF
Chassis	CSE-116TS-R706WBP4